

**DECLARATION FOR PATENT APPLICATION
/POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence and post office address are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled *Integrated Circuit with Improved Interconnect Structure and Process for Making Same*, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above identified specification, including claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Peter Courture, Esq.

J. Nicholas Gross, Esq.

Please address all telephone calls to *J. Nicholas Gross, Esq.* at telephone number (408) 342-1862
address all correspondence to *J. Nicholas Gross, Esq. 10950 N. Blaney Avenue Suite B, Cupertino, CA 95014*

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor (given name, family name): HSUAN, MIN-CHIH JOHN

Inventor's signature: [Signature] Date May 28, 91

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